



LV11B Series 3.3 V LVDS Clock Oscillators

January 2014

This device is supported for legacy designs only, LV11B is not recommended for new designs.

- Pletronics' LV11B Series is a quartz crystal controlled precision square wave generator with an LVDS output.
- Solder pad compatible with many 9x14 Plastic J-lead packages.
- FR4 base may or may not have a mechanical metal cover.
- Tape and Reel or cut tape packaging is available.
- 80 to 700 MHz
- 9.9mm x 13.97mm 'B' package
- Enable/Disable Function on pad 2
- Does NOT permit "wired-OR" of outputs
- Low Jitter

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following:

Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's

Weight of the Device: 2.18 grams or .82 grams or 1.51 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020C

Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit
V _{CC} Supply Voltage	-0.5V to +7.0V
V _i Input Voltage	-0.5V to V _{CC} + 0.5V
V _o Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

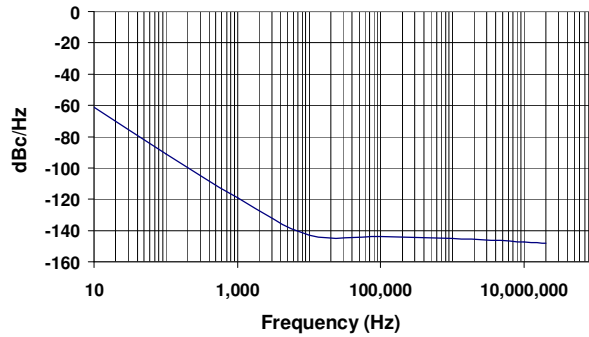
The thermal resistance junction to board is 60 to 100°C/Watt depending on the solder pads, ground plane and construction of the PCB.

Electrical Specification for 3.30V $\pm 10\%$ over the specified temperature range

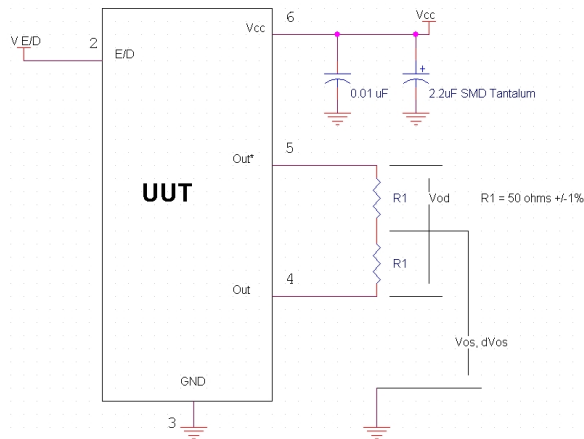
Item	Min	Max	Unit	Condition		
Frequency Range	1	700	MHz			
Frequency Accuracy	"45"	-50	+50	ppm	For all supply voltages, load changes, aging for 1 year, shock, vibration and temperatures	
	"44"	-25	+25			
	"20"	-20	+20			
Output Waveform	LVDS					
Output High Level	--	1.60	Volts	See load circuit R1 = 50 ohms		
Output Low Level	0.90	--	Volts			
Differential Output (V_{OD})	250	450	mVolts			
Output Offset Voltage (V_{OS})	1.125	1.375	Volts			≥ 80 MHz
Differential Output Error (dV_{OS})	--	50	mVolts			
Output Symmetry	45	55	%	Referenced to 50% of amplitude or crossing point		
Output T_{RISE} and T_{FALL}	300	700	pS	≥ 80 MHz	Vth is 20% and 80% of waveform	
	400	900	pS	< 80 MHz		
Jitter	-	0.2	pS RMS	Measured from 12KHz to 20MHz from Fnominal		
	-	2.8		Measured from 10Hz to 1MHz from Fnominal		
Vcc Supply Current	-	90	mA	≥ 80 MHz	Includes current of properly terminated device	
Enable/Disable Internal Pull-up	50	-	Kohm	To Vcc (equivalent resistance)		
V disable	-	0.8	Volts	Referenced to Ground		
V enable	2.0	-	Volts			
Enable	-	100	nS	Time for output to reach a logic state		
Disable time	-	100	nS	Time for output to reach a high Z state		
Start up time	-	5	mS	≥ 80 MHz	Measured from the time Vcc = 3.0V	
Operating Temperature Range	-10	+70	$^{\circ}$ C	Standard Temperature Range		
	-40	+85	$^{\circ}$ C	Extended Temperature Range "E" Option		
Storage Temperature Range	-55	+125	$^{\circ}$ C			

Specifications with Pad 2 E/D open circuit

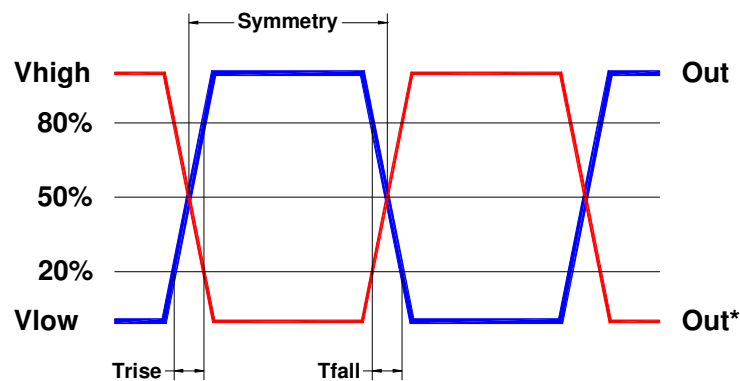
Typical Phase-Noise Response



Load Circuit



Test Waveform



Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A



ESD Rating

Model	Minimum Voltage	Conditions
Human Body Model	1500	MIL-STD-883 Method 3115
Charged Device Model	1000	JESD 22-C101

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)
Font is Courier New
Bar code is 39-Full ASCII

Label is 1" x 2.6" (25.4mm x 66.7mm)
Font is Arial

P/N:  LV1145BV-100.0M	
Customer P/N:  12345678	
Qty:  1000 D/C  0627B6	

RoHS Compliant 2nd LvL Interconnect Category=e4 Max Safe Temp=245C for 10s 2X Max

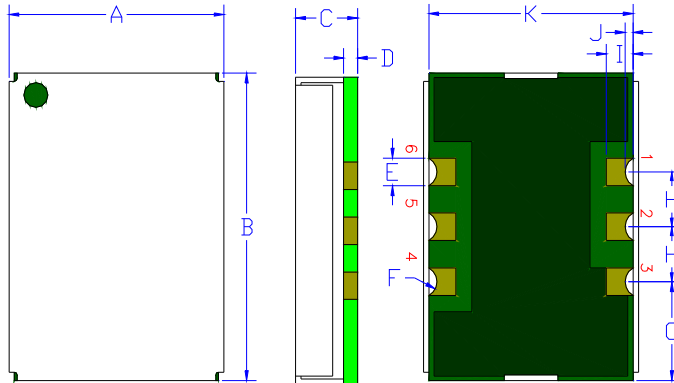
Layout and application information

Recommend connecting Pad 1 and Pad 2 together to permit the design to accept Enable/Disable on both input pads

For Optimum Jitter Performance, Pletronics recommends:

- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.

Mechanical:



FR4 PCB Base:
Solder masked
All via holes tented on bottom
Copper Clad ½ oz. Typical
Gold plated 0.02 µinch (0.5 µm)

Label:
White Kapton with Black Letters
-or--
Blue Epoxy heat cure ink covering
top with laser marked lettering

Cover:
Centered on the base
304 Stainless Steel
0.010 inch (0.25µm)
Electroless Nickel Plated
1 µinch (25 µm) typical

Pin 3 Ground plane is typical

Not to scale

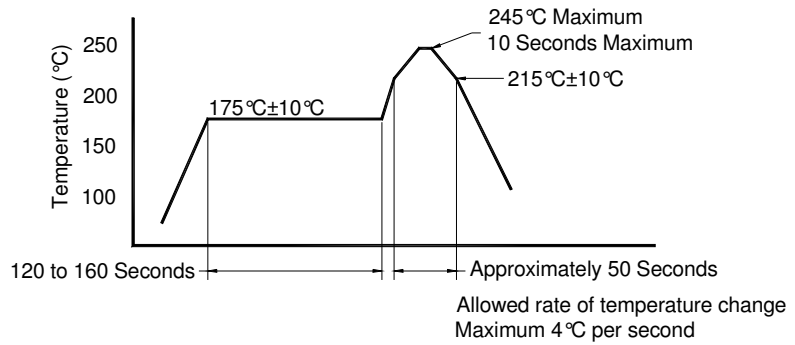
	Inches	mm
A	0.390 ±0.010	9.90 ±0.25
B	0.550 ±0.010	13.97 ±0.25
C	0.125 max	3.17 max
D ¹	0.026 typ.	0.66
E ¹	0.050	1.27
F ¹	0.028 R	0.72 R
G ¹	0.180	4.57
H ¹	0.100	2.54
I ¹	0.050	1.27
J ¹	0.015	0.38
K ¹	0.380	9.65

- The package is not hermetically sealed.
- This device may not have a cover.
- The sides are intentionally left open to permit cleaning material to freely flow in the package, thus minimizing the accumulation of contaminants during cleaning processes.
- The internal part of the package must be thoroughly dry before operating.

Pad	Function	Note
1	No connect	There is no internal connection to this pad
2	Output Enable/Disable	When this pad is not connected the oscillator shall operate. When this pad is <0.30 volts, the output will be inhibited (high impedance state.) Recommend connecting this pad to V _{CC} if the oscillator is to be always on.
3	Ground (GND)	
4	Output	The outputs must be terminated, 100 ohms between the outputs is the ideal termination. When disabled, the outputs are not in a high impedance state - can not be wire - or connected
5	Output*	
6	Supply Voltage (V _{CC})	Recommend connecting appropriate power supply bypass capacitors as close as possible.



Reflow Cycle (typical for lead free processing)



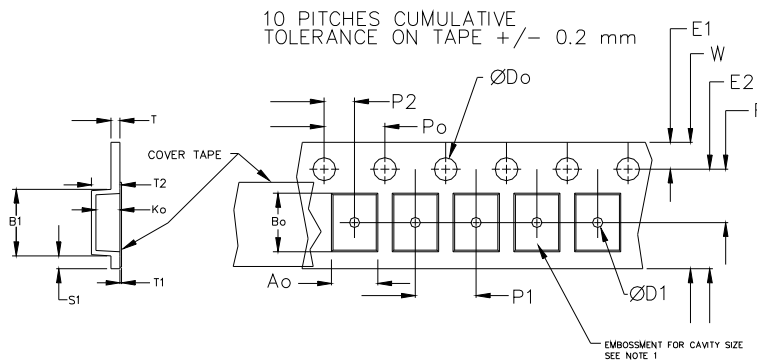
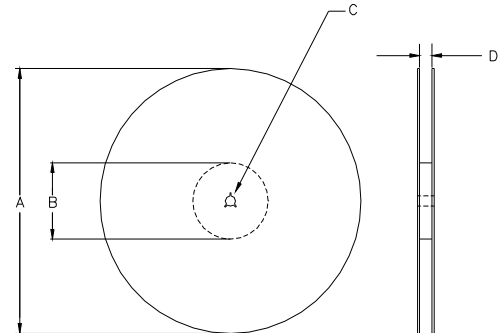
The part may be reflowed 2 times without degradation.

Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max	
8mm	1.5	1.0	1.75	4.0	2.0 ± 0.05	0.6	0.6	0.1	
12mm		1.5			2.0 ± 0.1				
16mm		+0.1 -0.0			1.5				2.0 ± 0.1
24mm		1.5			2.0 ± 0.1				

Variable Dimensions Table 2							
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko
24 mm	12.1	14.25	7.5 ± 0.1	16.0 ± 0.1	8.0	16.3	Note 1

Note 1: Embossed cavity to conform to EIA-481-B Dimensions in mm Not to scale



USER DIRECTION OF UNREELING →

REEL DIMENSIONS					
A	inches	7.0	10.0	13.0	Tape Width
	mm	177.8	254.0	330.2	
B	inches	2.50	4.00	3.75	Tape Width
	mm	63.5	101.6	95.3	
C	mm	13.0 +0.5 / -0.2			Tape Width
D	mm	---	---	24.4 +2.0 -0.0	

Reel dimensions may vary from the above

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